

# MASTR Progress Line

66-88 MHz RECEIVER MODELS 4ER40D10-15 (WIDE BAND)



**SPECIFICATIONS** 

FCC Filing Designation

Frequency Range

Audio Output

Sensitivity

12-dB SINAD (EIA Method) 20-dB Quieting Method

Selectivity

EIA Two-Signal Method 20-dB Quieting Method

Spurious Response

Frequency Stability

Modulation Acceptance

Squelch Sensitivity

Critical Squelch Maximum Squelch

Intermodulation (EIA)

Maximum Frequency Separation

Frequency Response

ER-40-D

66-88 MHz

5 watts at less than 5% distortion

0.4 µV 0.5 μV

-100 dB at  $\pm 30$  kHz

-7.5 dB

 $\pm.0005\%$ 

±15 kHz (wide-band)

Greater than 20 dB quieting (less than 2 µV)

-85 dB (adjacent channel, 40 kHz channels)

-60 dB

0.4%

+1 and -8 dB of a standard 6-dB per octave de-emphasis curve from 300 to 3000 Hz

(1000-Hz reference)

\*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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#### - WARNING -

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

#### DESCRIPTION

General Electric MASTR Progress Line Receiver Type ER-40-D is a double-conversion, superheterodyne FM receiver designed for operation on the 66-88 megahertz band.

The receiver is of single-unit construction and is completely housed in a copper-plated aluminum casting for maximum shielding and rigidity. The top compartment of the casting contains the RF, oscillator, converter, high IF and 1st low IF amplifier stages. The bottom portion of the casting contains the audio-squelch board.

#### **CIRCUIT ANALYSIS**

The MASTR Progress Line Receiver is completely transistorized, using silicon transistors for added reliability. Input leads to the receiver are individually filtered by the 20-pin feed-through by-pass connector J443. A regulated +10 volts is used for all receiver stages except the

audio PA stage which operates from the 12-volt system supply.

Centralized metering jack J442 is provided for use with General Electric Test Set Models 4EX3AlO or 4EX8KlO, 11 for ease of alignment and servicing. The Test Set meters the oscillator, multiplier, and limiter stages as well as the discriminator and regulated 10 volts.

#### RF AMPLIFIER (A343)

RF Amplifier (A343) consists of two high-Q helical resonators and an RF amplifier stage (Q1). The RF signal from the antenna is coupled by RF cable W441 to a tap on L347/L349. The tap is positioned to insure the proper impedance match to the antenna. RF energy is coupled through the two coils by an opening in the shield wall to the base of RF Amplifier Q1. The coils are tuned to the incoming frequency by air trimmer capacitors C343 and C344. The output of Q1 is coupled through four tuned circuits to the base of the first mixer.

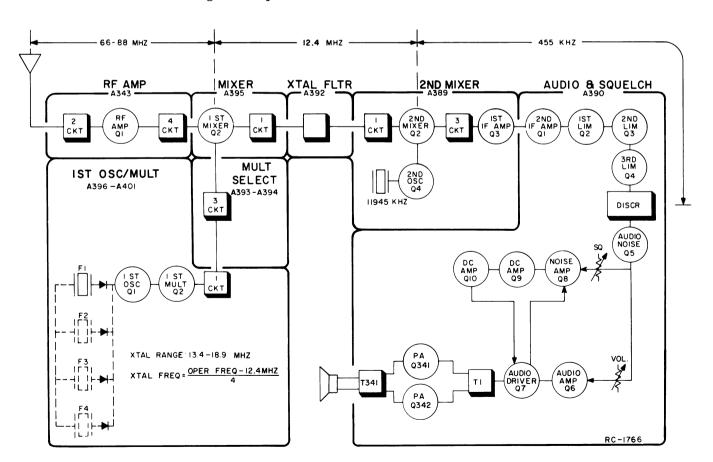


Figure 1 - Receiver Block Diagram

#### 1ST OSCILLATOR AND MULTIPLIER (A396-A40)

The receiver 1st oscillator operates in a transistorized Colpitts oscillator circuit. The oscillator crystal operates in a fundamental mode at a frequency of approximately 13 to 19 megahertz. The crystal is cut to provide temperature compensation at the high end of the temperature range and is thermistor compensated at low temperatures. This provides ±.0005% frequency stability as soon as the receiver is energized—without the warm-up time required by crystal ovens or warmers.

In single-frequency receivers, bias for the oscillator transistor is obtained by a jumper from H1 to H2 on the oscillator board.

In mult-frequency receivers, a diode is connected in series with the crystal, and up to three additional crystal circuits can be added. The 10-volt jumper is removed and the proper frequency is selected by switching the desired crystal circuit to +10-volts by means of a frequency selector switch on the control unit.

Switching the +10-volts to the crystal circuit forward biases the diode and reduces its impedance. This applies the crystal frequency to the base of oscillator transistor Ql. Feedback for the oscillator is developed across C21. The output is coupled to the base of 1st multiplier.

The output of the 1st multiplier (quadrupler Q2) is transformer-coupled (T12/T13) to multiplier selectivity assembly A393/A394. The 1st multiplier tank is tuned to four times the crystal frequency. The stage is metered at centralized metering jack J442-4 through metering network CR1, R1, C12 and C13.

#### MULTIPLIER SELECTIVITY ASSEMBLY (A393/A394)

Following the 1st multiplier tank (T12/T13) are three additional tuned circuits (A393/A394-L1, -L2 and -L3). Capacitor C20/C21 couples the multiplier selectivity output to the base of the first mixer.

#### 1ST MIXER (A395) AND CRYSTAL FILTER (A392)

The RF signal from the RF Amplifier and the injection voltage from the 1st multiplier are applied to the base of 1st mixer A395-Q1. The mixer collector tank (L4 and C3) is tuned to 12.4 megahertz and provides impedance matching to the high IF filter.

#### 2ND OSCILLATOR, 2ND MIXER AND 1ST LO IF AMPLIFIER

A389-Q4 operates in a Colpitts oscillator circuit, with feedback supplied through C18. The oscillator low-side injection

voltage (11945 kHz) is applied to the base of the 2nd mixer.

The High IF signal from the filter and the injection voltage from the 2nd oscillator is applied to the base of 2nd mixer Q2. The 445-kHz mixer output is applied to three tuned low IF circuits, L1, L2 and L3. These tuned circuits are required for shaping the nose of the IF waveform, and for rejecting any undesired output frequencies from the 2nd mixer.

The low IF signal is applied to the base of lst low IF amplifier Q3. The output of Q3 is R-C coupled to the base of the 2nd low IF amplifier.

#### 2ND LO IF AMPLIFIER AND LIMITERS (A390)

Additional amplification of the low IF signal going to the limiter stages is provided by 2nd low IF amplifier A390-Q1. This stage is metered at J442-2 through a metering network consisting of C19, CR3 and R25.

Following the 2nd low IF amplifier are three R-C coupled limiter stages (A390-Q2, -Q3 and -Q4). The 1st limiter is metered at J442-3 through metering network C20, CR4 and R26.

#### DISCRIMINATOR (A390)

The limiter output is applied to a Foster-Seely type discriminator, where diodes CR1 and CR2 rectify the 455-kHz signal to recover the audio. The discriminator is metered at J442-10 through metering network C16 and R23.

#### AUDIO-NOISE AMPLIFIER (A390)

The discriminator output is coupled through a low-pass filter (C16, C18, R21 and R22) to the base of audio-noise amplifier Q5. The filter removes any 455-kHz signal remaining in the discriminator output. Q5 operates as a emitter-follower to match the discriminator impedance to the VOLUME and SQUELCH control. The stage also provides power gain.

#### AUDIO AMPLIFIERS (A390)

Any audio present in the incoming signal is coupled from the emitter of Q5 through the VOLUME control and a de-emphasis network to the base of audio amplifier Q6. The de-emphasis network consists of C22, C23, C24, R30 and R31.

Audio driver Q7 follows the audio amplifier. Base bias and AC feedback for Q6 are connected from the base of Q7 through R32, R33, R63, C42 and C29. Negative feedback and base bias for Q7 is supplied through R37. The audio driver output is coupled

through transformer T1 to provide phase inversion for the push-pull audio PA stage.

Q341 and Q342 operate as a push-pull, class AB audio PA stage. The PA output is coupled through audio transformer T341 to the loudspeaker. The yellow and white tertiary windings of T341 supply balanced feedback to the emitter of Q7. The feedback winding minimizes distortion and prevents the pick-up of external electrical noise.

The PA stage provides a 5-watt output at less than 5% distortion into a 3.5-ohm load at the receiver output terminals (3.2-ohms at the Control Unit). Base bias for the PA stage and the elimination of crossover distortion is controlled by bias adjust potentiometer R43. The potentiometer is set at the factory as shown in STEP 1 of the receiver Test Procedure.

- NOTE -

Do not adjust bias adjust potentiometer R43 unless PA transistors Q341 and Q342 have been replaced.

Audio high and low are also present at centralized metering jack J442, and can be used as shown in STEP 1 of the Test Procedure.

#### SQUELCH (A390)

Noise from the audio-noise amplifier operates the squelch circuit. With no carrier present in the receiver, this noise is coupled to the base of noise amplifier Q8 through a high-pass filter which attenuates frequencies below 3 kHz. The filter consists of C30, C31 and R45, as well as C34 and L3 in the collector circuit of Q8. The gain of Q8 is determined by the Squelch control, which varies the bias on the base of Q8. Thermistor RT2 keeps the critical squelch constant over wide variations in temperature.

The output of noise amplifier Q8 is rectified by diodes CR5 and CR6, and filtered by C36 and C37 to produce a negative DC voltage. This DC voltage is applied to the base of DC amplifier Q9, turning it off. When turned off, the collector voltage of Q9 rises to approximately 8 volts, turning on DC amplifier Q10. When conducting, the collector voltage of Q10 drops to almost ground potential, which removes the base bias to audio amplifier Q6 and audio driver Q7, turning them off.

When the receiver is quieted by a signal (unsquelches), the noise in the receiver is reduced, turning DC amplifier Q9 on and DC amplifier Q10 off. This allows the audio stages to conduct so that sound is heard in the speaker. A network composed of C38, CR7 and R62 slows down the switching action of Q10, preventing an obnoxious "thump" from being heard in the speaker.

Resistor R53 connects from the emitter of audio driver Q7 to the emitter of noise amplifier Q8, providing a hysteresis loop in the squelch circuit. When a weak signal opens the squelch, the signal level may be reduced by 4 to 6 dB without the squelch closing. This limits squelch "flutter" or "picket-fense" operation.

With audio driver Q7 conducting, a positive voltage through R53 helps to reduce the gain of noise amplifier Q8. This positive feedback provides a quick, positive switching action in the squelch circuit. When the receiver squelches, audio driver Q7 turns off and its emitter potential drops to zero. This reduces the DC feedback through R53 to the emitter of noise amplifier Q8. Reducing the feedback causes Q8 to conduct harder, turning the audio stages off quickly.

Keying the transmitter removes the  $\pm 10$  volts from J19, turning off DC amplifier Q9 and turning on Q10 to mute the receiver.

#### MAINTENANCE

#### DISASSEMBLY

To service the receiver from the top --

- Pull locking handle down and pull radio about one inch out of mounting frame.
- 2. Pry up cover at rear of receiver.
- 3. Slide cover back and lift off.

To service the receiver from the bottom --

- Pull locking handle down. Pull radio out of mounting frame.
- 2. Remove screws in bottom cover. Pry up cover to back of receiver.
- 3. Slide cover back and lift off.

To remove the receiver from the system frame --

- Loosen the two Phillips-head retaining screws in from casting (see Figure 2), and pull casting away from system frame.
- 2. Remove the four screws in the back cover.
- Remove the two screws holding the receiver at each end of the system frame.
- 4. Disconnect the antenna jack and the 20-pin connector from the front of the receiver, and slide the unit out of the the system frame.

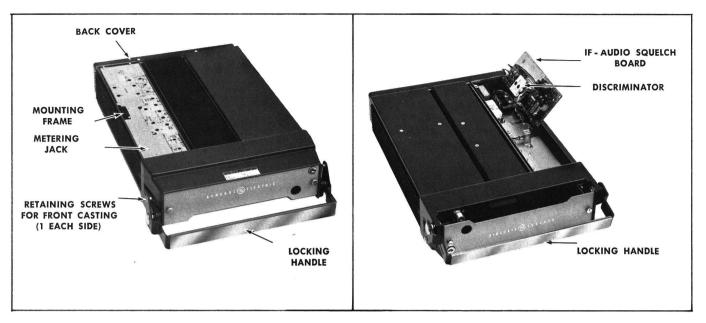


Figure 2 - Removing Top Cover

Figure 3 - Removing Bottom Cover

#### FRONT END ALIGNMENT

#### EQUIPMENT REQUIRED

- 1. GE Test Set Models 4EX3A10, 4EX8K10, 11 (or 20,000 ohms-per-volt Multimeter with a 1-volt scale).
- 2. A 455 kHz and 66-88 MHz signal source. Connect a one-inch piece of insulated wire no larger than .065-inch diameter to generator output probe.

#### PRELIMINARY CHECKS AND ADJUSTMENTS

METERING POSITION

STEP | 4EX3A10 | - at J442

MULTIMETER

1. Connect Test Set to Receiver Centralized Metering Jack J442 and set meter sensitivity switch to the TEST 1 position (or 1-volt position on 4EX8K10, 11)

TUNING CONTROL READING

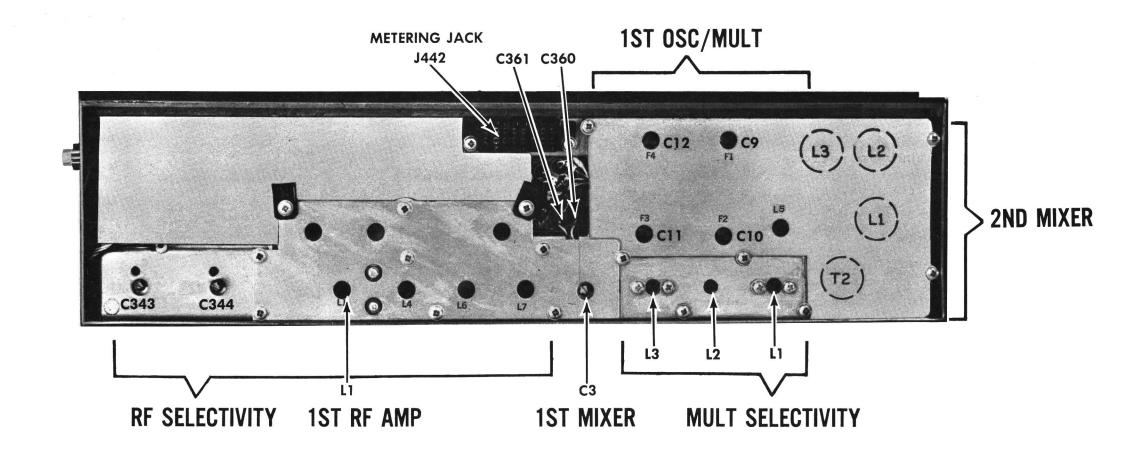
METER

PROCEDURE

- 2. With Test Set in Position J, check for regulated +10 volts. If using Multimeter, measure from C360 to C361.
- 3. If using Multimeter, connect the positive lead to J442-16 (Ground).

#### ALIGNMENT PROCEDURE

ILL					
			OSCILLATOR/MULTIPI	IER	
1.	D (MULT-1)	Pin 4	L5 (on 1st OSC/MULT and L1, L2, & L3 (on MULT SELECTIV- ITY)	See Pro- cedure	Tune L5 on 1st OSC/MULT and L1 on MULT SELECTIVITY for maximum meter reading. Next tune L2 for minimum meter reading. Then tune L3 for a maximum meter reading. Change voltage scale if necessary.
			RF AMPLIFIER & SELEC	TIVITY	
2.	A (DISC)	Pin 10		Zero	Apply an on-frequency signal adjacent to L7. Adjust the signal generator for discriminator zero.
3.	B (2nd IF Amp)	Pin 2	L1 (1st RF Amp), L4, L6, L7, C343 and C344 (RF SELECTIV- ITY)	Maximum	Apply an on-frequency signal to antenna jack, keeping below saturation. Tune L1, L4, L6, L7, C343 and C344 for maximum meter reading.
4.	"	11	L5 (1st OSC/MULT) and L1, L2 and L3 (MULT SELECTIVITY)	Maximum	Apply an on-frequency signal as above, keeping below saturation. Tune L5 on 1st OSC/MULT and L1, L2 and L3 on MULT SELECTIVITY for maximum meter reading.
			FREQUENCY ADJUSTME	NT	
5.	A (DISC)	Pin 10	C9 on 1st OSC (C10, C11 or C12 for multifrequency)	Zero	Apply an on-frequency signal to the antenna jack.  Tune C9 for zero discriminator reading. In multifrequency units, tune C10, C11 or C12 as required.  —————————————  For proper frequency control of the receiver, it is recommended that all frequency adjustments be made when the equipment is at a temperature of approximately 75°F. In no case should frequency adjustments be made when the equipment is outside the temperature range of 50° to 90°F.



## IF-AUDIO & SQUELCH **REMOVE** THREE SCREWS **DISCRIMINATOR** TO SWING **BOARD UP** (HIGH): -----0 10 000 000000

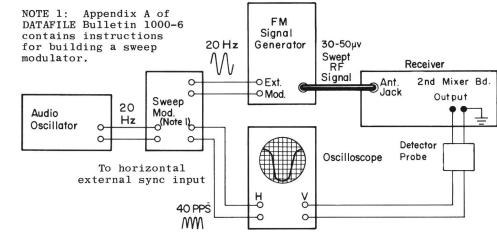


Figure 4 - Test Setup for 20-Hz Double-Trace Sweep Alignment

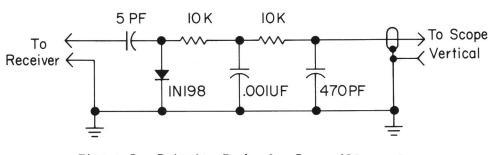


Figure 5 - Detector Probe for Sweep Alignment

#### **COMPLETE RECEIVER ALIGNMENT**

2. A 455-kHz signal source (GE Test Set Model 4EX7A10) and 66-88 signal source. Connect a one-inch piece of insulated wire no larger than .065-inch diameter to generator output probe.

#### PRELIMINARY CHECKS AND ADJUSTMENTS

1. Connect Test Set to Receiver Centralized Metering Jack J442, and set meter sensitivity switch to the TEST 1 position (or 1-volt position on 4EX8K10, 11).

2. For a large change in frequency or a badly mis-aligned receiver, set crystal trimmer C9 to mid-capacity. In multi-frequency receivers, set C10, C11 or C12 to mid-capacity as required. Where the maximum frequency spacing is less than 150 kHz, align the unit on channel F1. If the frequency spacing is greater than 150 kHz, align the receiver with a center frequency crystal.

3. With Test Set in Position J, check for regulated +10 volts. If using Multimeter, measure from C360 to C361.

4. If using Multimeter, connect the positive lead to J442-16 (Ground).

#### ALIGNMENT PROCEDURE

	METERING	POSITION								
STEP	GE Test Set	Multimeter - at J442	TUNING CONTROL	METER READING	PROCEDURE					
DISCRIMINATOR & OSCILLATOR										
1.	A (DISC)	Pin 10	L1 and L2 (on IF- AUDIO SQUELCH board)	Zero	Remove three screws and swing open the IF-AUDIO & SQUELCH board. Adjust L1 (diprimary) 1/2 turn counterclockwise from the bottom of coil Next, apply a 455-1 signal to J2 and J4 and adjust L2 (disc secondary) for zero meter reading.					
2.	A (DISC)	Pin 10		See Pro- cedure	Alternately apply a $450$ -kHz and $460$ -kHz signal and check for readings of at leg 0.3 volt, but not more than 0.5 volt on GE Test Set. Both readings must be wit in .05 volt. Do not attempt to balance disc closer than readings obtained if within .05 volt limit.					
3.	D (MULT-1)	Pin 4		See Pro- cedure	Tune L5 on 1st OSC/MULT and L1 on MULT SELECTIVITY for maximum meter reading. Tune L2 for mimimum meter reading. Change voltage scale if necessary. Then to L3 for maximum meter reading. Repeat step 3.					
				RF	AMPLIFIER & SELECTIVITY					
4.	A (DISC)	Pin 10		Zero	Apply an on-frequency signal adjacent to L7. Adjust the signal generator for discriminator zero.					
5.	B (2nd IF AMP)	Pin 2	L7, L6 and L4 (RF SELECTIVITY)	Maximum	Apply an on-frequency signal and tune for maximum meter reading as shown below keeping signal below saturation.					
	AMI )				Apply Signal Generator Probe to:					
					L6 L7					
					L4 L6 L4					
6.	"	"	C343, C344 and L1 (1st RF Amp)	Maximum	Apply an on-frequency signal to the antenna jack. Tune C343, C344 and L1 for maximum meter reading, keeping signal below saturation.					
7.	"	**	L1 (1st RF Amp), L4, L6, L7, C343 and C344 (RF SELECTIVITY)		Apply an on-frequency signal as above, keeping below saturation. Tune L1, L4, L7, C341 and C342 for maximum meter reading.					
8.	"	"	L2 (MULT SELECTIV- ITY)	Maximum	Apply on-frequency signal as above, keeping below saturation. Tune L2 and L3 MULT SELECTIVITY) for maximum meter reading.					
		1		-	2ND MIXER					
Tho 1	st and 2nd	mivon and	low IF girauits have be	on aligned	at the factory and will normally require no further adjustment. If adjustment					

The 1st and 2nd mixer, and low IF circuits have been aligned at the factory and will normally require no further adjustment. If adjustment is necessary, use the procedure outlined in STEPS 9, 10 and 11. C3 (on 1st mixer) provides impedance matching for the crystal filter input and should only be tuned with observing IF trace on oscilloscope.

- NOTE -Refer to DATAFILE BULLETIN 1000-6 IF Alignment of Two-Way Radio RM Receivers for helpful suggestions on how to

determine when IF Alignment is required.

9.	B (2nd IF AMP)	Pin 2	L3, L2, L1, T2 (2nd Mixer)	Maximum	Apply on-frequency, unmodulated signal and tune L3, L2, L1 and T2 for maximum meter reading, keeping signal below saturation.
10.			L3, L2, L1, T2 (2nd Mixer)		Connect scope, signal generator and detector as shown in Figure 4. Set signal generator level for 30-50 µV and modulate with 16-20 kHz at 20 Hz. With detector at the collector of Q3 (2nd mixer board output), tune L3, L2, T1, T2 (2nd Mixer) and C3 (1st Mixer) for double trace as shown on scope pattern.
11.	A (DISC)	Pin 10		See Pro- cedure	Check to see that discriminator idling voltage is within $\pm .05$ volt of zero with no signal applied. Check to see that modulation acceptance bandwidth is greater than 15 kHz.
	1	1			FREQUENCY ADJUSTMENT
12.	A (DISC)	Pin 10	C9 on 1st OSC (C10, C11 or C12 for	Zero	Apply an on-frequency signal to the antenna jack. Tune C9 for zero discriminator reading. In multi-frequency units, tune C10, C11 or C12 as required.

range of 50° to 90°F.

- NOTE -For proper frequency control of receiver, it is recommended that all frequency adjustments be made when the equipment is at a temperature of approximately 75°F. In no case should frequency adjustments be made when the equipment is outside the temperature

#### ALIGNMENT PROCEDURE

66—88 MHz MASTR RECEIVER MODELS 4ER40D10-15

Issue 2

LBI-3974

EQUIPMENT REQUIRED 1. GE Test Set Models 4EX3Al0, 4EX8Kl0, 11 (or 20,000 ohms-per-volt Multimeter with a 1-volt scale). LBI-3974

SIGNAL GENERATOR

DEVIATION

INPUT

(CONNECTS TO J443)

#### TEST PROCEDURES

These Test Procedures are designed to help you to service a receiver that is operating---but not properly. The problems encountered could be low power, poor sensitivity, distortion, limiter not operating properly, and low gain. By following the sequence of test steps starting with Step 1, the defect can be quickly localized.

Once the defective stage is pin-pointed, refer to the "Service Check" listed to correct the problem. Additional corrective measures are included in the Troubleshooting Procedure. Before starting with the Receiver Test Procedures, be sure the receiver is tuned and aligned to the proper operating frequency.

#### TEST EQUIPMENT REQUIRED

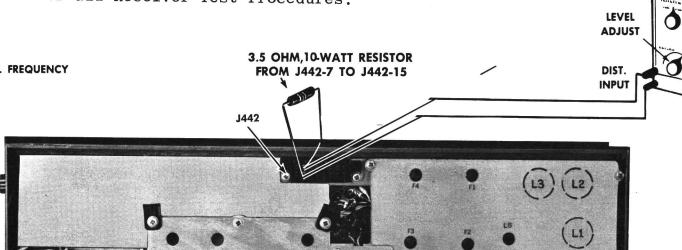
#### for test hookup shown:

1. Distortion Analyzer similar to: Heath #1M-12

2. Signal Generator similar to: Measurements #M-560

6 dB attenuation pad

The test equipment is hooked to the receiver as shown for all Receiver Test Procedures.

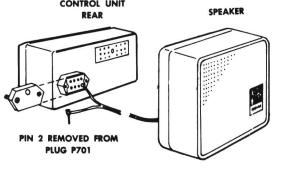


COMPONENT TOP VIEW



PA AI

PA BIAS ADJUST R43



DISTORTION ANALYZER

IF-AUDIO & SQUELCH BOARD
(COMPONENT VIEW)

#### STEP 1

# AUDIO POWER OUTPUT AND DISTORTION

TEST PROCEDURE

Measure Audio Power Output as follows:

- A. Connect a 1,000-microvolt test signal modulated by 1,000 hertz ±3.3 kHz deviation to the antenna jack J441.
- B. With Five-Watt Speaker:

Disconnect speaker lead pin from J701-2 (on rear of Control Unit).

Connect a 3.5-ohm load resistor from J442-15 to J442-7. Connect the Distortion Analyzer input across the resistor as shown.

VOLTMETER SCALE ON

DISTORTION ANALYZER

5-WATT

1111

With Handset:

Lift the handset off of the hookswitch. Connect the Distortion Analyzer input from J442-15 to J442-7.

- C. Set the VOLUME control for five-watt output (4.18 VRMS).
- D. Make distortion measurements according to manufacturer's instructions. Reading should be less than 5%.

#### SERVICE CHECK

If the distortion is more than 5%, or maximum audio output is less than five watts, make the following checks:

- E. Battery and regulator voltage---low voltage will cause distortion. (Refer to Receiver Schematic Diagram for voltages.)
- F. P.A. Bias Adjust (R43)--Turn the SQUELCH control fully counterclockwise. Then connect a milliameter in series with the +12-volt lead at P443-11. With no signal in, adjust R43 for a reading of approximately 20 milliamps. This adjustment should not be necessary unless an output transistor has been replaced.
- G. Audio Gain (Refer to Receiver Troubleshooting Procedure).
- H. Discriminator Alignment (Refer to Receiver Alignment on reverse side of page).

#### STEP 2

#### USABLE SENSITIVITY (12 dB SINAD)

#### TEST PROCEDURE

Measure sensitivity of the receiver modulated at the standard test modulation as follows:

- A. Be sure Test Step 1 checks out properly.
- B. Reduce the Signal Generator output from setting in Test Step 1A.
- C. Adjust Distortion Analyzer LEVEL control for a +2 dB reading.
- D. Set CONTROL from LEVEL to DISTORTION reading. Repeat Steps 2B and 2C until difference in reading is 12 dB (+2 dB to -10 dB).
- E. The 12-dB difference (Signal plus Noise and Distortion to noise plus distortion ratio) is "usable" sensitivity level. Reading should be less than 0.4 microvolts with audio output at least 2.5 watts (2.9 volts RMS across the 3.5-ohm receiver load).

#### SERVICE CHECK

If the sensitivity level is more than 0.4 microvolts, make the following checks:

- F. Alignment of RF stages (Refer to RF Alignment in Receiver Alignment on reverse side of page).
- G. Gain measurements as shown on the Receiver Troubleshooting Procedure.

#### STEP 3

## MODULATION ACCEPTANCE BANDWIDTH (IF BANDWIDTH) TEST PROCEDURE

- A. Be sure Test Steps 1 and 2 check out properly.
- B. Set Signal Generator output for twice the microvolt reading obtained in Test Step 2D.
- C. Increase Signal Generator frequency deviation.
- D. Adjust LEVEL Control for +2 dB.



LEVEL

LEVEL DISTORTION

ON DISTORTION ANALYZER

- E. Set CONTROL from LEVEL to DISTORTION reading. Repeat Steps 3C, 3D and 3E until difference between readings becomes 12 dB (from +2 dB to -10 dB).
- F. Deviation control reading for the 12-dB difference is the Modulation Acceptance Bandwidth of the receiver. It should be more than ±15 kHz (but less than ±19 kHz).

#### SERVICE CHECK

If the Modulation Acceptance Bandwidth test does not indicate the proper width, make gain measurements as shown on the Receiver Troubleshooting Procedure.

#### STEP I - QUICK CHECKS

#### TEST SET CHECKS

These checks are typical voltage readings measured with GE Test Set Model 4EX3AlO in the Test 1 position, or Model 4EX8K10 or 11 in the 1-volt position.

Metering Position	Reading With No Signal In	Reading with 1 Micro- volt Unmodulated
A (Disc Idling)	Less than ±.05	
B (2nd IF)	.03 VDC	0.2 VDC
C (1st Lim)	0.5 VDC	0.8 VDC
D (Mult-1)	0.6 VDC	
J (Reg. +10 volts)	+10 VDC (15 volts full scale)	

#### SYMPTOM CHECKS

SYMPTOM	PROCEDURE
NO SUPPLY VOLTAGE	Check power connections and continuity supply leads, and check fuse in power supply. If fuse is blown, check recei for short circuits.
NO REGULATED 10 VOLTS	Check the 12-volt supply. Then check regulator circuit (See Troubleshooting Procedure for Power Supply).
LOW 1ST LIM READING	Check supply voltages and then check oscillator reading at J442-4 as shown STEP 2.
	Make SIMPLIFIED VTVM GAIN CHECKS from 2nd Mixer through 1st Limiter stages a shown in STEP 2A.
LOW OSCILLA- TOR READING	Check alignment of Oscillator (Refer t Front End Alignment Procedure).
	Check voltage readings of 1st Oscillat Multiplier Q1/Q2.
	Check crystal Y1.
LOW RECEIVER SENSITIVITY	Check Front End Alignment (Refer to Fr End Alignment Procedure).
	Check antenna connections, cable and relay.
	Check voltage readings of RF Amp and 1 and 2nd Mixers.
	Make SIMPLIFIED GAIN CHECKS (STEP 2A).
LOW AUDIO	Check Audio PA voltage readings (Q341/Q342).
	Make simplified gain and waveform chec of Audio and Squelch stages (Steps 2A 2B).
	Check unsquelched voltage readings in Audio section (Refer to Schematic Diagram).
IMPROPER SQUELCH OPERATION	Check voltage and resistance readings Squelch circuit (Refer to Schematic Digram).
	Make gain and waveform checks (Steps 2 and 2B).
DISCRIMINA- TOR IDLING	See if discriminator zero is on 455 kH
TOO FAR OFF ZERO	Check alignment of IF coils (Refer to Alignment Procedure).
HIGH DISTOR- TION AT LOW	Check PA Bias Adjust R43 (Refer to STE of Test Procedure).

STEP 3-VOLTAGE RATIO READINGS ---

EQUIPMENT REQUIRED:

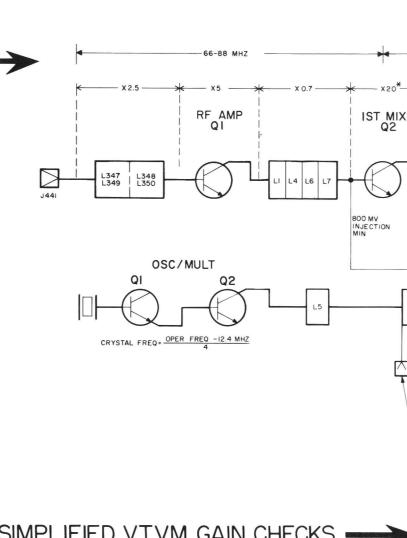
- 1. RF VOLTMETER (SIMILAR TO BOONTON MODEL 91-CA OR MILLIVAC TYPE MV-18 C.
- 2. SIGNAL ON RECEIVER FREQUENCY (BELOW SATURATION). CORRECT FREQUENCY CAN BE DETERMINED BY ZEROING THE DISCRIMINATOR. USE 1,000 HERTZ SIGNAL WITH 3.3 KHZ DEVIATION

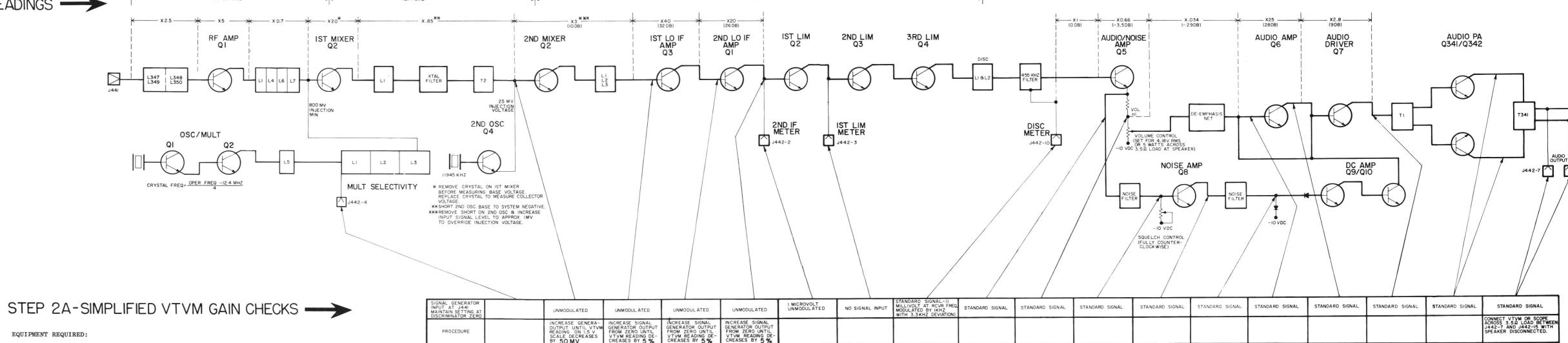
#### PROCEDURE:

- 1. APPLY PROBE TO INPUT OF STAGE (FOR EXAMPLE, BASE OF RF AMP). PEAK RESON-ANT CIRCUIT OF STAGE BEING MEASURED AND TAKE VOLTAGE READING (E1).
- 2. MOVE PROBE TO INPUT OF FOLLOWING STAGE (1ST MIXER). REPEAK FIRST RESONANT CIR-CUIT THEN PEAK CIRCUIT BEING MEASURED AND TAKE READING (E2).
- 3. CONVERT READINGS BY MEANS OF THE FOLLOWING FORMULA.

VOLTAGE RATIO =

4. CHECK RESULTS WITH TYPICAL VOLTAGE RATIOS SHOWN ON DIAGRAM.





RC-1767

#### EQUIPMENT REQUIRED:

- 1. VTVM-AC & DC
- 2. Signal generator (measurements M560 to equivalent).

#### PRELIMINARY STEPS:

- 1. Set VOLUME control for 4.18 volts across 3.5-ohm load. If this cannot be obtained, set to approx. 70% of max. rotation.
- 2. Set SQUELCH control fully counterclock-
- Receiver should be properly aligned.
- 4. Connect VTVM between system negative and points indicated by arrow.

# STEP 2B-AUDIO & SQUELCH WAVEFORMS ----

GENERATOR OUTPUT GENERATOR OUTPUT SHOULD BE APPROX

5 MICROVOLTS

SHOULD BE APPROX

0.3 MICROVOLTS

#### EQUIPMENT REQUIRED:

- Oscilloscope.
- 2. Signal generator (measurements M560 to equivalent).

#### PRELIMINARY STEPS:

READING

- 1. Set VOLUME control for 4.18 volts across 3.5-ohm load. If this cannot be obtained, set to approx. 70% of max. rotation.
- Set SQUELCH control fully counterclockwise.
- 3. Receiver should be properly aligned.
- 4. Connect oscilloscope between system negative and points indicated by arrow.

#### 0.5 MS/DIV 5 VOLTS/DIV I VOLT/DIV 0.5 VOLTS/DIV 50 MILLIVOLTS/DIV 2 VOLTS/DIV 12 V P-P 4 V P-P STANDARD SIGNAL (I MILLIVOLT AT RECEIVER FRE MODULATED BY IKHZ WITH 3.3 KHZ DEVIATION) NOISE WAVE FORM (NO SIGNAL INPUT)

0.55 VAC

#### TROUBLESHOOTING PROCEDURE

66-88 MHz MASTR RECEIVER MODELS 4ER40D10-15

Issue 1

LBI-3974

# IF-AUDIO & SQUELCH BOARD A390 (19C311803, Sh. 1, Rev. 2) (19C311803, Sh. 2, Rev. 3) 2ND MIXER A389 BOTTOM VIEW

CRYSTAL FILTER

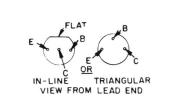
A 392

T34I

# IST OSCILLATOR/MULTIPLIER A396-A40I RUNS ON SOLDER SIDE RUNS ON BOTH SIDES C363 TO J4 ON IF AUDIO TOP VIEW TO J2 ON IF-AUDIO J442 016. . . . . . . 9 0 MULTIPLIER-SELECTIVITY IST RF AMP IST MIXER A393 - A394 A343 A395 OUTLINE DIAGRAM

R2 CIB CIB

(19B216045, Sh. 1, Rev. 3) (19B216045, Sh. 2, Rev. 3)



NOTE LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

TRANSISTOR LEAD IDENTIFICATION

(19R621267, Rev. 5)

ALTERNATE LI & L2

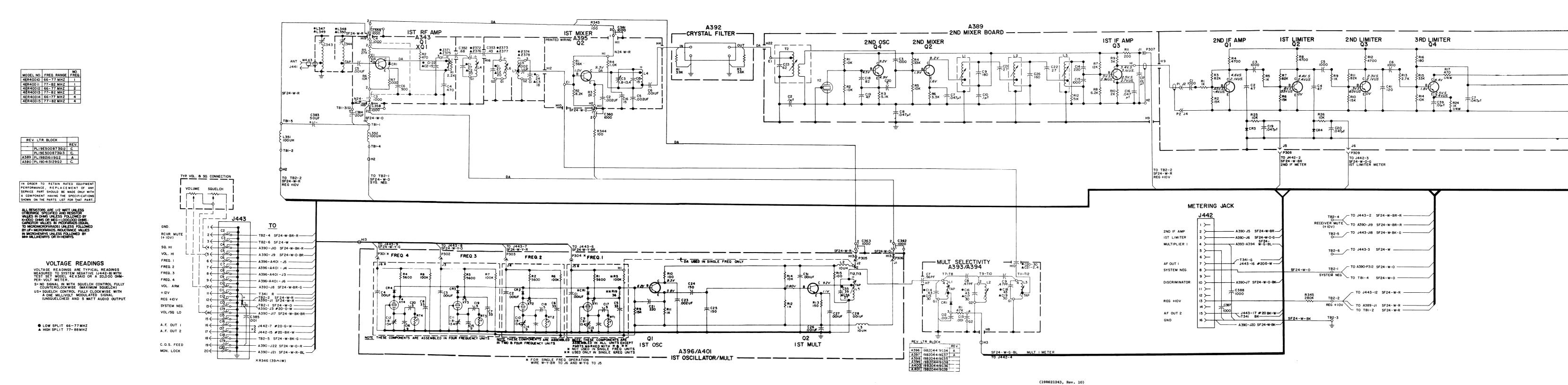
PIN NUMBER MARKING ON SIDE OF COIL CAN OR COLOR DOT IDENTIFIES PIN NUMBER I ON DISCRIMINATOR AND 2ND MIXER COILS.

Issue 2

66—88 MHz MASTR RECEIVER MODELS 4ER40D10-15

		PARTS LIST	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
		LBI-3976A			INDUCTORS	C12	5494481-P108	Ceramic disc: 470 pf ±10%, 1000 VDCW; sim to	C51*	5494481-P127	Ceramic disc: 2700 pf ±20%, 1000 VDCW; sim to	R29	3R77-P182J	Composition: 1800 ohms ±5%, 1/2 w.	R71*	3R77-P133J	Composition: 13,000 ohms ±5%, 1/2 w. Added			INDUCTORS	A396 thru		FIRST OSCILLATOR ASSEMBLY
		66-88 MHz RECEIVER	Ш	19C311181-G3	Coil. Includes tuning slug 4038368-Pl.	C13	19Al15680-P107	RMC Type JF Discap.  Electrolytic: 100 µf +150% -10%, 15 VDCW; sim	C52*	19B209243-P117	RMC Type JF Discap. Added by REV B.  Polyester: 0.22 µf ±20%, 50 VDCW. Added by	R30	3R77-P102J	Composition: 1000 ohms ±5%, 1/2 w.	R72*	3R77-P362J	REV B.  Composition: 3600 ohms ±5%, 1/2 w. Added by	ы	19B204822-P7	Coil.	A401		A396 19B204419-G34 (4ER40D10) A397 19B204419-G37 (4ER40D11)
		WODELS 4ER40D10 - 4ER40D15	L3			C14	19Al15680-P104	to Mallory Type TT.	C53*	5496267-P213	REV B.	R31	3R77-P821J	Composition: 820 ohms ±5%, 1/2 w.	R73*	3R77-P473J	REV B.  Composition: 47,000 ohms ±5%, 1/2 w. Added		5491798-P5	Tuning slug.			A398 19B204419-G35 (4ER40D12) A399 19B204419-G38 (4ER40D13) A400 19B204419-G36 (4ER40D14)
			P1	4029840-P2		and C15	15A113080-P104	Electrolytic: 50 µf +150% -10%, 25 VDCW; sim to Mallory Type TT.	and C54*	5490207-P213	Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D. Added by REV B.	R32*	3R77-P752J	Composition: 7500 ohms ±5%, 1/2 w. Deleted by REV B.			by REV B.	T9 and T10		COIL ASSEMBLY T9 19B204981-G3 T10 19B204981-G4			A401 19B204419-G39 (4ER40D15)
SYMBOL	GE PART NO.	DESCRIPTION	P2	4029840-P1	Contact, electrical: sim to AMP 41854.	C17	19B209243-P7	Polyester: 0.1 µf ±20%, 50 VDCW.			DIODES AND RECTIFIERS	R33*	3R77-P912J	Composition: 9100 ohms ±5%, 1/2 w. Earlier than REV B.	R74*	3R77-P362J	Composition: 3600 ohms ±5%, 1/2 w. Added by REV B.						
		2233.11.13.1			TRANSISTORS	C18	5494481-P108	Ceramic disc: 470 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	CRI	19A115250-P1	Silicon.	R34	3R77-P203J 3R77-P332K	Composition: 20,000 ohms ±5%, 1/2 w.  Composition: 3300 ohms ±10%, 1/2 w.	R75*	3R77-P473J	Composition: 47,000 ohms ±5%, 1/2 w. Added by REV B.	C13	5494481-P11	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to	C1 thru C4	5494481-P112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
A343		RF AMPLIFIER ASSEMBLY	Q2	19A115245-P1	Silicon, NPN.	C21*	19B209243-P3	Polyester: 0.022 µf ±20%, 50 VDCW. Earlier than REV B.	and CR2			R35	3R77-P330K	Composition: 33 ohms ±10%, 1/2 w.	R76*	3R77-P912J	Composition: 9100 ohms ±5%, 1/2 w. Added by REV B.		5496218-P254	RMC Type JF Discap.  Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef	C5	5496219-P751	Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef
		19B204772-G2	Q3	19A115123-P1	Silicon, NPN; sim to Type 2N2712.	C22	19B209243-P1 19B209243-P116	Polyester: 0.01 μf ±20%, 50 VDCW.	CR3 and	4038056-P1	Germanium.	R36	3R77-P681J	Composition: 680 ohms ±5%, 1/2 w.	R77*	3R152-P562J	Composition: 5600 ohms ±5%, 1/4 w. Added by			-80 PPM.	thru C8		-750 PPM.
СЗ	5493392-P7	Coremic feed-thrus 001 of 100g og 500 VDGW.	Q4	19A115245-P1	Silicon, NPN.	C23	19B209243-P107	Polyester: 0.15 µf ±10%, 50 VDCW.  Polyester: 0.1 µf ±10%, 50 VDCW.	CR5	19A115250-P1	Silicon.	R37*	3R77-P822J	Composition: 8200 ohms ±5%, 1/2 w. Deleted by REV B.	R78*	3R77-P100J	Composition: 10 ohms ±5%, 1/2 w. Added by	C17	5496218-P250	Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef -80 PPM.	C9 thru	5491271-P106	Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189-6-5.
and C4		Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen-Bradley Type FASC.			RESISTORS	C24*	19B209243-P106	Polyester: .068 µf ±10%, 50 VDCW. Deleted by REV B.	CR7			R38*	3R 77-P752J	Composition: 7500 ohms ±5%, 1/2 w. Earlier than REV B.	R79*	3R152-P393J	REV B.  Composition: 39,000 ohms ±5%, 1/4 w. Added	ļ		INDUCTORS	C13	5496219-P40	Ceramic disc: 9 pf ±0.25 pf, 500 VDCW, temp
C5	5494481-P12	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R1 and R2	3R 77-P103K	Composition: 10,000 ohms ±10%, 1/2 w.	C25	5496267-P6	Tantalum: 33 μf ±20%, 10 VDCW; sim to	CR8*	19 A1 55 250-P1	Silicon. Added by REV B.	R39*	3R77-P622J 3R77-P820J	Composition: 6200 ohms ±5%, 1/2 w.  Composition: 82 ohms ±5%, 1/2 w.			by REV B.	L2	19B204981-P6	Coil.	thru C16		coef 0 PPM.
C6	7484398-P4	Silver mica: 500 pf ±10%, 500 VDCW; sim to	R3	3R 77-P512J	Composition: 5100 ohms ±5%, 1/2 w.	C26*	5496267-P28	Sprague Type 150D.  Tantalum: 0.47 µf ±20%, 35 VDCW; sim to Sprague			JACKS AND RECEPTACLES		3R 77-P131J	Earlier than REV B. Composition: 130 ohms ±5%, 1/2 w.			THERMISTORS	711	5491798-P5	Tuning slug.  COIL ASSEMBLY	C17 thru	19C300685-P93	Ceramic disc: 5 pf $\pm 0.1$ pf, 500 VDCW, temp coef 0 PPM.
		Underwood Type J-1-HF.	R4	3R152-P333K	Composition: 33,000 ohms ±10%, 1/4 w.		19B209243-P14	Type 150D. Earlier than REV B. Polyester: 0.33 µf ±20%, 50 VDCW.	J1 thru	4033513-P4	Contact, electrical: sim to Bead Chain L93-3.	R40	3R 77-P241J	Composition: 240 ohms ±5%, 1/2 w.	RT1	5490828-P41	Thermistor: 30 ohms ±10%, color code black, white, sim to Globar Type Bl2llH-4.	and Tl2		T11 19B204548-G3 T12 19B204548-G4	C20 C21	5496219-P771	Ceramic disc: 220 pf ±5%, 500 VDCW, temp coef
CR1	4038642-P1	DIODES AND RECTIFIERS	R5 R6	3R152-P103J 3R77-P332K	Composition: 10,000 ohms ±5%, 1/4 w.  Composition: 3300 ohms ±10%, 1/2 w.	C27	5496267-P6	Tantalum: 33 µf ±20%, 10 VDCW; sim to Sprague Type 150D.	J 22			R41*	3R152-P240J 3R77-P300J	Composition: 24 ohms ±5%, 1/4 w. Earlier than REV B. Composition: 30 ohms ±5%, 1/2 w.	RT2	5490828-P9	Thermistor: 10,000 ohms ±10%, color code yellow; sim to Globar Type 551H8.				C23	5494481-P114	-750 PPM.
	- FI	Germanium.	R7	3R77-P123K	Composition: 3300 ohms ±10%, 1/2 w.  Composition: 12,000 ohms ±10%, 1/2 w.	C28*	5496267-P229	Tantalum: 0.68 µf ±10%, 35 VDCW; sim to Sprague Type 150D. Deleted by REV B.	L1	19C311181-G1	Coil. Includes tuning slug 4038368-Pl.	R42*	3R77-P200J	Composition: 20 ohms ±5%, 1/2 w.	RT3*	5490828-P9	Thermistor: 10,000 ohms ±10%, color code yellow; sim to Globar Type 551H8, Added by REV B.	C18	5496218-P254	Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef		İ	Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
Ø1	19A115342-P1	Silicon, NPN; sim to Type 2N918.	R8	3R77-P622J	Composition: 6200 ohms ±5%, 1/2 w.	C29*	5496267-P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to	L2	19C311181-G2	Coil. Includes tuning slug 4038368-Pl.		3R77-P160J	Earlier than REV B. Composition: 16 ohms ±5%, 1/2 w.				C19	5496218-P250	-80 PPM.  Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef	C24	5490008-P31	Silver mica: 150 pf $\pm 5\%$ , 500 VDCW; sim to Electro Motive Type DM-15.
		RESISTORS	R9 R10	3R 77-P302J	Composition: 3000 ohms ±5%, 1/2 w.	C30*	19B209243-P16	Sprague Type 150D. Deleted by REV B.  Polyester: 0.15 \mu f \pm 20%, 50 VDCW. Deleted	L3	19A1 27134-G1	Choke. Includes tuning slug 7486872-P7.	R43	19B209358-P10	Variable, carbon film: approx 25 to 250 ohms ±20%, 0.2 w; sim to CTS Type X-201.	71	19Al16040-Pl	TRANSFORMERS	(20	5491601-P129	-80 PPM. Tubular: 3.0 pf ±10%, 500 VDCW.	C25	5496219-P467	Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef -220 PPM.
R5	3R152-P273K	Composition: 27,000 ohms ±10%, 1/4 w.	R11	3R77-P202J	Composition: 2000 ohms ±5%, 1/2 w.  Composition: 200 ohms ±5%, 1/2 w.	C31*	19B209243-P102	by REV A.		10.11.51.00 -1		R44	19B209022-P10	Wirewound: .27 ohms ±10%, 2 w; sim to IRC Type BWH.			Pri: 19.3 ohms ±10% DC res, Sec: 23.5 ohms ±10% DC res.	C21	5491601-P127	Tubular: 2.4 pf ±5%, 500 VDCW.	C26 thru	5494481-P112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
R6	3R152-P103K 3R152-P102K	Composition: 10,000 ohms ±10%, 1/4 w.  Composition: 1000 ohms ±10%, 1/4 w.	R12*	3R 77-P513J	Composition: 51,000 ohms ±5%, 1/2 w. Earlier than REV A.	1		Polyester: 0.015 µf ±20%, 50 VDCW. Deleted by REV A.	thru Q6	19A115123-P1	Silicon, NPN; sim to Type 2N2712.	R45*	3R77-P123J	Composition: 12,000 ohms ±5%, 1/2 w. Deleted	A392		CRYSTAL FILTER ASSEMBLY			INDUCTORS	C28 C31	5494481-P112	
	0.102-71024	· ·		3R77-P822J	Composition: 8200 ohms ±5%, 1/2 w.	C32 C33	19B209243-P7 19B209243-P17	Polyester: 0.1 \( \mu f \pm \pm 20\%, 50 \) VDCW.  Polyester: 0.22 \( \mu f \pm \pm 20\%, 50 \) VDCW.	Q7	19Al15300-P4	Silicon, NPN; sim to Type 2N3053.	R46	3R 77-P913J	Composition: 91,000 ohms ±5%, 1/2 w.			19B205682-G2	L3	19B204548-P6	Coil.		3454461-F112	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.
XQ1	5490277-p1	Transistor: 4 contacts rated at 1 amp at				C35	19 B2 09 243-P5	Polyester: 0.047 µf ±20%, 50 VDCW.	Q8	19Al15123-Pl	Silicon, NPN; sim to Type 2N2712.	R47	3R152-P273K	Composition: 27,000 ohms ±10%, 1/4 w.	FLI	100004000 01		11	5491798-P5	Tuning slug.			DIODES AND RECTIFIERS
		400 VRMS; sim to Elco 3303.	Т2		COIL ASSEMBLY 19B216120-G2	C36	19 B2 09 243-P7	Polyester: 0.1 µf ±20%, 50 VDCW.	Q10	19A115362-P1 19A115123-P1	Silicon, NPN; sim to Type 2N2925. Silicon, NPN; sim to Type 2N2712.	R48*	3R77-P332J	Composition: 3300 ohms ±5%, 1/2 w. Deleted by REV A.		19C304290-G1	Bandpass, 12.4 MHz.	A395		FIRST MIXER ASSEMBLY 19B204430-G9	CR1 thru CR4	19A115348-P1	Silicon.
A389		SECOND MIXER 19B216119-G2				C37*	5496267-P28 5496267-P17	Tantalum: 0.47 µf ±20%, 35 VDCW; sim to Sprague Type 150D. Earlier than REV B.		10.20120 11	' ' ' ' ' '	R49	3R77-P103J	Composition: 10,000 ohms ±5%, 1/2 w.	Rl	3R152-P392K					CR4		
		REV A	C23	5496218-P258	Ceramic disc: 62 pf ±5%, 500 VDCW, temp coef			Tantalum: 1.0 µf ±20%, 35 VDCW; sim to Sprague Type 150D.	R1	3R77-P102K	RESISTORS	R50 R51	3R 77-P222J 3R 77-P103J	Composition: 2200 ohms ±5%, 1/2 w.  Composition: 10,000 ohms ±5%, 1/2 w.	R3	3R152-P362J	Composition: 3600 ohms ±5%, 1/4 w.	C2	5494481-P114	Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	J1	4033513-P4	Contact, electrical; sim to Bead Chain L93-3.
				5491798-P3	Tuning slug.	C38*	5496267-P10 5496267-P14	Tantalum: 22 µf ±20%, 15 VDCW; sim to Sprague Type 150D. Earlier than REV B. Tantalum: 15 µf ±20%, 20 VDCW; sim to	R2	3R77-P153J	Composition: 15,000 ohms ±5%, 1/2 w.	R52	3R77-P682J	Composition: 6800 ohms ±5%, 1/2 w.	A393		MULTIPLIER SELECTIVITY ASSEMBLY	СЗ	5491271-P106	Variable, subminiature: approx 2,1-12,7 pf,	16		•
C2 C3	19B209243-P7 5494481-P112	Polyester: 0.1 \( \mu f \) \( \pm 20\%, 50 \) VDCW.  Ceramic disc: .001 \( \mu f \) \( \pm 10\%, 500 \) VDCW; sim				C39		Sprague Type 150D.	R3	3R77-P823K	Composition: 82,000 ohms ±10%, 1/2 w.	R53*	3R77-P303J	Composition: 30,000 ohms ±5%, 1/2 w. Deleted by REV A.	and A394		A393 19B204827-G3 (4ER40D10, 12, 14) A394 19B204827-G4 (4ER40D11, 13, 15)	C5	5494481-P114	750 v peak; sim to EF Johnson 189-6-5.  Ceramic disc: .002 µf ±10%, 1000 VDCW; sim to	L2	7488079-P16	
67	19B209243-P5	to RMC Type JF Discap.	¥2	19A110398-P1	Quartz: freq 11945.00 KHz, temp range -30°C to	C39 C40*	19B209243-P1 5496267-P28	Polyester: 0.01 µf ±20%, 50 VDCW.  Tantalum: 0.47 µf ±20%, 35 VDCW; sim to Sprague	R4 R5	3R 77-P4 72K 3R 77-P102K	Composition: 4700 ohms ±10%, 1/2 w.  Composition: 1000 ohms ±10%, 1/2 w.	R54*	3R77-P822J	Composition: 8200 ohms ±5%, 1/2 w. Deleted by REV A.		1		C6	5494481-P12	RMC Type JF Discap.  Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to	and L3		Jeffers 4421-7K.
and C8	198209243-P3	Polyester: 0.047 μf ±20%, 50 VDCW.			+75 C.		19B209243-P117	Type 150D. Earlier than REV B. Polyester: 0.22 µf ±10%, 50 VDCW.	R6	3R77-P153J	Composition: 15,000 ohms ±5%, 1/2 w.	R55	3R77-P103K	Composition: 10,000 ohms ±10%, 1/2 w.	C8	5491601-P13		11	1	RMC Type JF Discap.			TRANSISTORS
С9	5496219-P369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef -150 PPM.	A390		IF AUDIO AND SQUELCH 19D413129-G2 REV B	C41	5490008-P129	Silver mica: 120 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.	R7	3R77-P823K	Composition: 82,000 ohms ±10%, 1/2 w.	R56	3R77-P224J	Composition: 0.22 megohms ±5%, 1/2 w.	and C9	5151551 115	Components Type MC.	C15 and C16	5496218-P244	Ceramic disc: 15 pf ±5%, 500 VDCW, temp coef -80 PPM.	Q1 and Q2	19Al15330-Pl	Silicon, NPN.
C10	19B209243-P7	Polyester: 0.1 µf ±20%, 50 VDCW.				C42*	19B209243-P4	Polyester: 0.033 µf ±20%, 50 VDCW. Deleted by REV B.	R8 R9	3R77-P472K 3R77-P102K	Composition: 4700 ohms ±10%, 1/2 w.	R57	3R77-P103K	Composition: 10,000 ohms ±10%, 1/2 w.			RESISTORS	-					RESISTORS
C12*	5496219-P369	Ceramic disc: 180 pf ±5%, 500 VDCW, temp coef -150 PPM. Deleted by REV A.	Cl	5494481-P111		C43*	5496267-P213	Tantalum: 2.2 μf ±10%, 20 VDCW; sim to	R10	3R 77-P153J	Composition: 1000 ohms ±10%, 1/2 w.  Composition: 15,000 ohms ±5%, 1/2 w.	R58 R59	3R77-P181K 3R77-P393K	Composition: 180 ohms ±10%, 1/2 w.  Composition: 39,000 ohms ±10%, 1/2 w.	R1	3R152-P473K	Composition: 47,000 ohms ±10%, 1/4 w.	E1	4038104-P1	Lug: solder dipped brass.	R1 thru	3R152-P562J	Composition: 5600 ohms ±5%, 1/4 w.
C14	5496219- <b>P</b> 471	Ceramic disc: 220 pf ±5%, 500 VDCW, temp coef	C2	5496219-P717	RMC Type JF Discap.	C44*	5494481-P124	Sprague Type 150D. Deleted by REV B.  Ceramic disc: 1500 pf ±10%, 1000 VDCW; sim to	R11	3R 77-P823K	Composition: 82,000 ohms ±10%, 1/2 w.	R60 and	3R77-P103K	Composition: 10,000 ohms ±10%, 1/2 w.						IN DUCTORS	R4	3R152-P104K	Composition, 0.30 seember 4307 5 11
C15	7491395-P109	-220 PPM.  Ceramic disc: .001 µf ±10%, 500 VDCW; sim to			Ceramic disc: 47 pf ±10%, 500 VDCW, temp coef -750 PPM.		4029003-P104	RMC Type JF Discap. Earlier than REV A. Silver mica: 680 pf ±10%, 500 VDCW; sim to	R12 R13	3R 77-P472K	Composition: 4700 ohms ±10%, 1/2 w.	R61	00.00		T7 and T8		COIL ASSEMBLY T7 19B204822-G3 T8 19B204822-G4	1.4	19A121082-G4	Toroidal coil.	thru R8	JR102-P104K	Composition: 0.10 megohm ±10%, 1/4 w.
C16	19B209243-P5	RMC Type JL.  Polyester: 0.047 uf ±20%. 50 VDCW.	C3	5494481-P111	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	C45*	5490008-P27	Electro Motive Type DM-20.  Silver mica: 100 pf ±5%, 500 VDCW; sim to	R13	3R 77-P272K 3R 77-P103J	Composition: 2700 ohms ±10%, 1/2 w.  Composition: 10,000 ohms ±5%, 1/2 w.	R62*	3R77-P103K 3R77-P223K	Composition: 10,000 ohms ±10%, 1/2 w. Earlier than REV B. Composition: 22,000 ohms ±10%, 1/2 w.	"						R9	3R152-P153J	Composition: 15,000 ohms ±5%, 1/4 w.
C17	19B209243-P1	Polyester: 0.047 µr ±20%, 50 VDCW.	C4	5496219-P717	Ceramic disc: 47 pf ±10%, 500 VDCW, temp coef -750 PPM.		5494481-P104	Electro Motive Type DM-15. Earlier than REV A. Ceramic disc: 220 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.	R15	3R 77-P333J	Composition: 33,000 ohms ±5%, 1/2 w.	R63*	3R77-P432J	Composition: 4300 ohms ±5%, 1/2 w. Deleted	C7	5491601-P15		92	19A115245-P1	Silicon, NPN.	R10	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.
C18	5490008-P25	Silver mica: 82 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	C5 and	5494481-P111	Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	C46	4029003-P108	Silver mica: 1000 pf ±10%, 500 VDCW; sim to	R16	3R77-P181K	Composition: 180 ohms ±10%, 1/2 w.	R64	3R77-P180J	by REV B.  Composition: 18 ohms ±5%, 1/2 w.	C12		Ceramic disc: .001 µf ±20%, 1000 VDCW; sim to			RE SI STOR S	R11 and R12	3R152-P102J	Composition: 1000 ohms ±5%, 1/4 w.
C19	5490008-P19	Silver mica: 47 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	C6 C7	100000040 55		C47*	19B209243-P17	Electro Motive Type DM-20.  Polyester: 0.22 µf ±20%, 50 VDCW. Added by	R17 R20	3R152-P471J 3R152-P472K	Composition: 470 ohms ±5%, 1/4 w.  Composition: 4700 ohms ±10%, 1/4 w.	R65*	3R77-P154K	Composition: 0.15 megohms ±10%, 1/2 w. Deleted REV R.	C14	5496218-P254	RMC Type JF Discap.  Ceramic disc: 43 pf ±5%, 500 VDCW, temp coef	R1	3R152-P563J 3R152-P822J	Composition: 56,000 ohms ±5%, 1/4 w.  Composition: 8200 ohms ±5%, 1/4 w.	R13	3R152-P151J	Composition: 150 ohms ±5%, 1/4 w.
C20	5490008-P1	Silver mica: 5 pf ±5%, 500 VDCW; sim to	C7 C8	19B209243-P5 5496219-P369	Polyester: 0.047 µf ±20%, 50 VDCW.  Ceramic disc: 180 pf ±5%, 500 VDCW.	C48*	19B209243-P1	REV A.	R23	3R77-P104K	Composition: 0.1 megohms ±10%, 1/2 w.	R66	3R 77-P472K	Composition: 4700 ohms ±10%, 1/2 w.	C15	5496218-P250	-80 PPM.  Ceramic disc: 30 pf ±5%, 500 VDCW, temp coef	R3	3R152-P822J 3R152-P202J	Composition: 2000 ohms ±5%, 1/4 w.	R14	3R152-P103J	Composition: 10,000 ohms ±5%, 1/4 w.
C21	5496219-P49	Electro Motive Type DMI5.  Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef	C9	5490008-P37	temp coef -150.			Polyester: 0.01 μf ±20%, 50 VDCW. Added by REV A.	R24	3R152-P102J	Composition: 1000 ohms ±5%, 1/4 w.	R67	3R152-P273K	Composition: 27,000 ohms ±10%, 1/4 w.		1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	-80 PPM.	R4	3R152-P102J	Composition: 1000 ohms ±5%, 1/4 w.	R15	3R152-P101K 3R152-P360J	Composition: 100 ohms ±10%, 1/4 w.  Composition: 36 ohms ±5%, 1/4 w.
and C22		0 PPM.	and C10		Silver mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.	C49*	5496267-P9	Tantalum: 3.3 µf ±20%, 15 VDCW; sim to Sprague Type 150D. Added by REV B.	R25 and R26	3R 77-P103K	Composition: 10,000 ohms ±10%, 1/2 w.	R68*	3R77-P682J 3R77-P752J	Composition: 6800 ohms ±5%, 1/2 w. Earlier than REV A.			DIODES AND RECTIFIERS	.					
C26*	5496219-P368	Ceramic disc: 160 pf ±5%, 500 VDCW, temp coef -150 PPM. Added by REV A.	C11	5496219-P656	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef -470 PPM.	C50*	19B209243-P7	Polyester: 0.1 µf ±20%, 50 VDCW. Added by REV B.	R27	3R77-P753J	Composition: 75,000 ohms ±5%, 1/2 w.	R69		Composition: 7500 ohms ±5%, 1/2 w.  Composition: 7500 ohms ±5%, 1/2 w.	CR1	7777146-P3	Germanium; sim to Type 1N90.				R Tr5	19B209284-P7	Disc: 62 ohms res nominal at 25%C, color code
					554 5561 STO FFE.				and R28			1				1					RT5 thru RT8		violet.
J1	4033513-P4	JACKS AND RECEPTACLES																					
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\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

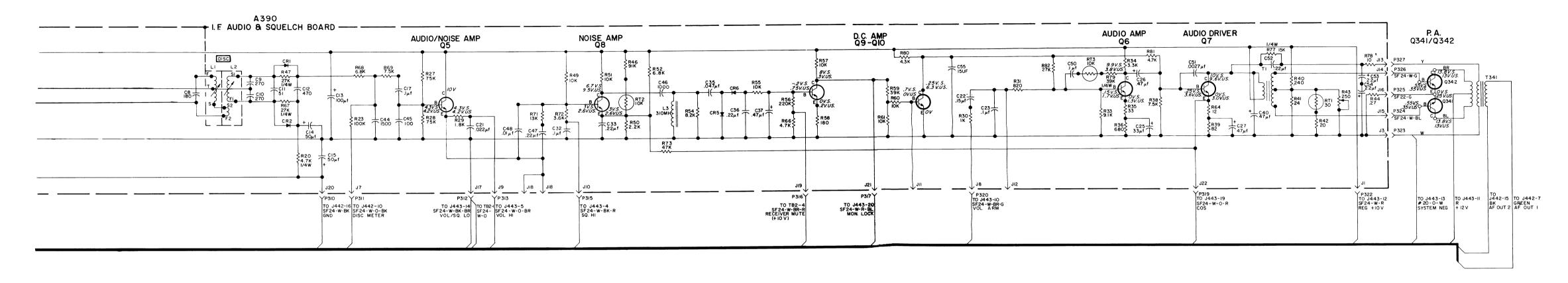


#### SCHEMATIC DIAGRAM

66-88 MHz MASTR RECEIVER MODELS 4ER40D10-15

Issue 2

(19D413167 Po.,



#### SCHEMATIC DIAGRAM

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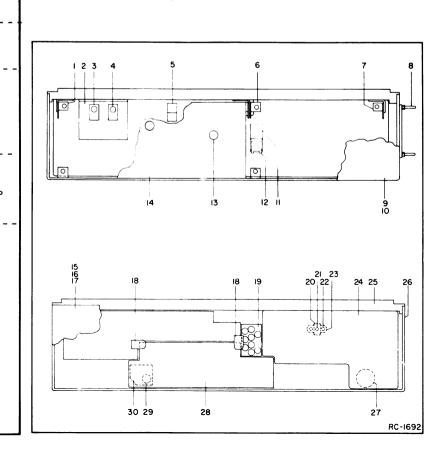
66-88 MHz MASTR RECEIVER MODELS 4ER40D10-15

#### LBI-3974

12

T12 and T13  C55 C56 L5  XY1 thru XY4  Y1 thru XY4			,			]		
and T13  C55  C56  L5  XY1 thru XY4  Y1 thru Y4  352  353  358 358 358 388  388  21*  441  442  443  347  infru 350  C343  and								INDUCTORS
XY1 thru XY4  Y1 thru XY4  Y1 thru Y4  Y1		COIL ASSEMBLY T12 19B204766-G3 T13 19B204766-G4	P301 thru P313	4039840-P2	Contact, electrical; sim to Amp 42827-2.	L1	19B204832-P6 5491798-P5	Coil. Tuning slug.
XY1 thru XY4  Y1 thru XY4  Y1 thru Y4  Y1			P315 thru P317	4039840-P2	Contact, electrical; sim to Amp 42827-2.	Z374		COIL ASSEMBLY 19B204831-G1
15  XY1 thru XY4  Y1 thru Y4  3552 3553 3588 3588 3683 3884 3885 3887 3888 2384 441 442 4443 347 441 442 443 350	5496218-P253	Ceramic disc: 39 pf ±5%, 500 VLW, temp coef -80 PPM.	P319 and	4039840-P2	Contact, electrical; sim to Amp 42827-2.			
XY1 thru XY4  Y1 thru Y4  2352 2353 2358 2358 2384 2385 2384 2385 2387 2388  R1*  4441 4442 4443 24443	5496218-P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	P320 P322	4029840-P2	Contact, electrical; sim to Amp 42827-2.	C1	5496218-P248	Ceramic disc: 24 pf ±5%, 500 VDCW, temp coef -80 PPM.
XY1 thru XY4  Y1 thru Y4  2352 2353 2358 2358 2384 2385 2384 2385 2387 2388  R1*  4441 4442 4443 24443		INDUCTORS	P323	4029840-P1	Contact, electrical; sim to Amp 41854.	C5	5494481-P13	Ceramic disc: .002 µf ±20%, 1000 VDCW; sim to
XY1 thru XY4  Y1 thru Y4  2352 2353 2358 2358 2384 2385 2384 2385 2387 2388  R1*  4441 4442 4443 24443	19A121481-P1	Coil.	P324	4029840-P2	Contact, electrical; sim to Amp 42827-2.			RMC Type JF Discap.
Thru XY4  Y1 thru Y4  2352 2353 2358 2358 2358 2384 2385 2384 2385 2384 2385 2384 2385 2384 2385 2384 2385 2384 2385 2387 2441 2441 24443 25443 250  C343 2644 26443 26443	5491798-P5	Tuning slug.	P325	40 29 840 P1	Contact, electrical; sim to Amp 41854.			INDUCTORS
Thru XY4  Y1 thru Y4  352  353  358  Shru 363  388  388  388  388  81*  441  442  443  347  Ahru 350			P326	4029840-P2	Contact, electrical; sim to Amp 42827-2.	Ll	19B204831-P6	Coil.
Thru XY4  Y1 thru Y4  352 353 358 363 388 388 388 81* 441 442 443 347 hru 350		SOCKETS	P327	40 29 84 0-P1	Contact, electrical; sim to Amp 41854.		5491798-P5	Tuning slug.
thru Y4  352  353  358  shru 363  384  385  387  and  347  hru 350  C343  and		Refer to Mechanical Parts (RC-1692),				Z375		COIL ASSEMBLY 19B204842-G2
thru Y4  352  353  358 hru 363  384  385  387 nd 388  E1+  441  442  443  347 hru 350			Q341* and	19 A1 16 20 3-P2	Silicon, NPN. Earlier than REV B.			190204642-02
thru Y4  352  353  358 hru 363  384  385  387 nd 388  E1+  441  442  443  347 hru 350		When reordering, give GE Part number and specify	Q342*	19A115948-P1	Silicon, NPN.			
thru Y4  352  353  358  shru 363  384  385  387  and  347  hru 350  C343  and		exact frequency needed.  66-88 MHz crystal freq = (OF - 5,30 MHz) ÷ 4.			RESISTORS	C2	5496218-P244	Ceramic disc: 15 pf ±5%, 500 VDCW, temp coef -80 PPM.
352 353 358 hru 363 383 384 385 387 and 388 81* 441 442 443	19B206576-P13	Quartz: freq range 13400.00 to 16150.00 KHz.	R343 and	3R152-P101K	Composition: 100 ohms ±10%, 1/4 w.	СЗ	5491601-P17	Tubular: 0.68 pf ±10%, 500 VDCW; sim to Quali Components Type MC.
353 358 363 383 384 385 387 368 388 31* 441 442 443 350		temp range -30°C to +85°C. (66-77 MHz)	R344 R345	5495948 <b>P</b> 444	Deposited carbon: 0.28 megohms ±1%, 1/2 w; sim to Texas Instrument CDL/2MR.	C4	5494481-P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
353 358 hru 363 383 384 385 387 nd 388 81* 441 442 443 347 hru 350		CHASSIS 19E500872-G12 4ER40D10, 12, 14	R346*	3R78-P390K	Composition: 39 ohms $\pm 10\%$ , 1 w. Added by REV B.			
353 358 374 383 384 385 387 348 388 387 341 441 441 442 443 347 350		19E500873-G13 4ER40D11, 13, 15 REV B				ш	19B204842-P8	Coil.
153 158 158 163 183 184 185 185 187 188 188 184 141 141 142 143 143 150			T341	19Al16041-P1	Audio freq: freq range 300 to 4000 Hz, Pri: 1.00 ohm ±15% DC res,			
358 383 384 385 387 34 341 441 442 443 347 347 347 350	5491601-P117	Tubular: 0.68 pf ±5%, 500 VDCW; sim to Quality			Sec 1: .23 ohm ±10% DC res.	R1	3R152-P222K	Composition: 2200 ohms ±10%, 1/4 w.
158 163 183 184 185 187 184 188 187 184 188 188 187 184 185 187 184 185 187 184 185 187 187 187 187 187 187 187 187		Components Type MC.			Sec 2: 10.5 ohms ±15% DC res.	R2	3R152-P471K	Composition: 470 ohms ±10%, 1/4 w.
183 884 885 887 888 888 888 888 888 888 888 888	5491601-P112	Tubular: 0.43 pf ±5%, 500 VDCW; sim to Quality Components Type MC.			TERMINAL BOARDS			MI SCELLANE OU S
83 84 85 87 48 88 1* 41 42 43 43 47 47 43 50	5493392-P7	Ceramic, feed-thru: .001 µf +100% -0%, 500 VDCW; sim to Allen-Bradley Type FA5C.	TB1 TB2	7487424-P7 7487424-P26	Miniature, phen: 4 terminals. Miniature, phen: 6 terminals.		5491798-P5	Tuning slug.
384 385 387 387 388 388 341 341 342 343 347 347 343 347	19A115680-P4			1101121-120		Z376		COIL ASSEMBLY
385 387 3488 311* 441 442 443 347 350	194113080-14	Electrolytic: 50 µf +150% -10%, 25 VDCW; sim to Wallory Type TT.				and Z377		19B204832-G2
87 dd 88 1* 41 42 43 47 47 47 47 43 447	19A115680-P3	Electrolytic: 20 µf +150% -10%, 25 VDCW; sim to Mallory Type TT.	W443	19B205634-G3	(Part of J441).			
11* 141 142 143 147 141 150	7774750-P4	Ceramic disc: .001 µf +100% -0%, 500 VDCW.			TUNED CIRCUITS	C2	5496218- <b>P24</b> 6	Ceramic disc: 20 pf ±5%, 500 VDCW, temp coef -80 PPM.
11* 141 142 143 347 171 180 180 180 180 180 180 180 180 180 18	5494481-P12	Ceramic disc: .001 µf ±10%, 1000 VDCW; sim to	Z371		COIL ASSEMBLY 19B204842-G1			Jo Fra.
41 42 43 47 47 47 50		RMC Type JF Discap.						INDUCTORS
41 42 43 47 rru 50		DIODES AND RECTIFIERS		5400010		L1	19B204832-P6	Coil.
42 43 47 ru 50 C343 and	19A116062-P2	Selenium: sim to 6RS20VJlBAA. Added by REV A.	C1	5496218-P247	Ceramic disc: 22 pf ±5%, 500 VDCW, temp coef -80 PPM.		5491798-P5	Tuning slug.
142 143 347 aru 150 C343 and			С3	5491601-P17	Tubular: 0.68 pf ±10%, 500 VDCW; sim to Quality Components Type MC.	Z378		COIL ASSEMBLY 19B204831-G2
442 443 947 hru 950 C343 and	19B209122-P1	JACKS AND RECEPTACLES	C4	5494481-P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to			
143 347 aru 350 C343 and	19B2U9122-P1	Connector, coaxial: includes cable (W441), approx 5 inches long.			RMC Type JF Discap.			
347 hru 350 C343 and	19B205689-G2	Connector: 18 contacts.			INDUCTORS	СЗ	5496218-P245	Ceramic disc: 18 pf ±5%, 500 VDCW, temp coef -80 PPM.
C343	19C303426-G1	Connector: 20 pin contacts.	L1	19B204842-P8	Coil,	C5	5494481-P13	Ceramic disc: .002 µf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C343		INDUCTORS		5491798-P5	Tuning slug.			
C343		COIL ASSEMBLY L347 and L348 19B204821-G1			RESISTORS			
and		L349 and L350 19B204821-G2	R1	3R152-P222K	Composition: 2200 ohms ±10%, 1/4 w.	L7	19B204831-P6 5491798-P5	Coil.
and			R2	3R152-P471K	Composition: 470 ohms ±10%, 1/4 w.		2491 189-19	Tuning slug.
C344	19B209159-P1	Variable, subminiature: approx 1.40-3.25 pf, 750 v peak; sim to EF Johnson 189,	Z372		COIL ASSEMBLY			MECHANICAL PARTS
			and 2373		19B204832-G1	l	19B204583-G3	(SEE RC-1692)
51 d	7488079-P72	Choke, RF: 100 µh ±10%, 2.6 ohms DC res; sim to Jeffers 4424-9K.				2	19B216727-P1	Support. (Used with Q301 and Q302).
52		ļ	Cl	5496218-P249	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -80 PPM.	3	19A116023-P2	Plate, insulated. (Used with Q301 and Q302).
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SYMBOL	GE PART NO.	DESCRIPTION
4	19A116022-P1	Insulator. (Used with Q301 and Q302).
5	4029851-P6	Clip, loop.
6	19B204583-G1	Hinge.
7	19B204583-G2	(Not Used).
8	19A121676-P1	Guide pin.
9	19C303495-G4	Bottom cover. (Station)
10	19C303385-G1	Bottom cover. (Mobile)
11	19Al 2l 297-Pl	Angle.
12	7160861-P4	Nut. (Used to secure cover).
13	4036555-P1	Insulator disc. (Used with Q7 on A390).
14	4035267-P2	Button, plug. (Used with A390).
15	19C303495-G3	Top cover. (Station, except Repeaters and VM)
16	19C303676-G2	Top cover. (Station, Repeaters and VM only).
17	19C303385-P2	Top cover. (Mobile)
18	4029851-P3	Clip, loop.
19	19A121383-P1	Support.
20	4033089-P1	Clip. (Part of XY1-XY4).
21	19B200525-P9	Rivet. (Part of XY1-XY4).
22	19A115793-P1	Contact, (Part of XY1-XY4).
23	19C311172-P1	Crystal socket. (Part of XY1-XY4).
24	19C303547-P1	Cover.
25	19C317344-P3	Heat sink.
26	19C3O3389-G1	Chassis.
27	4034252-P5	Can. (Used with Tl on A389).
28	19B204672-P1	Cover.
29	7162414-P1	Retainer, transistor. (Used with Q1 on A343).
30	19B204732-P1	Support.



#### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by those revisions.

#### CHASSIS AND RF ASSEMBLY 19E500873-G12 & 13

REV. A - To protect the receiver against positive voltage transients. Added thyrector CRI (19A116062-P2) between J443-11 and J443-13.

#### REV. B - To incorporate new PA transistors.

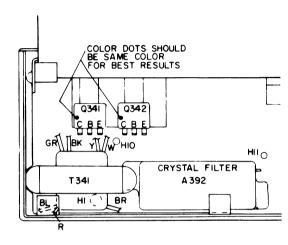
Changed	From	<u>To</u>
Q341/Q342	19A115948-P1	19A116203-

Insulator for

341/Q342 19A116023-P1 19A116023-P2

Added: R346 (3R78-P390K, 39 ohm ±10% 1 watt) between J443-16 and J443-17.

#### Outline Diagram Was



REV. C - To eliminate squelch opening thump in receivers with Channel Guard. Removed white-orange wire between J443-13 and TB2-1. Added a white-orange wire between P312 (or J17 on IF-Audio and squelch board) and TB2-1.

#### SECOND MIXER 19B216119-G2

REV. A - To facilitate tuning of low IF.

Changed	From	<u>To</u>
C12	5496219-P369, 180 pF	5496219-P368, 160 p

Added: R12 (3R77-P513J, 51,000 ohms ±5%) across L3.

#### IF AUDIO & SQUELCH BOARD A390 (19D413129-G2)

#### REV. A - To improve critical squelch.

Changed the following components

From	<u>To</u>
C30 (19B209243-P16, 0.15 μF)	C47 (19B209243-P17, 0.22 p
C31 (19B209243-P102, .015 μF)	C48 (19B209243-P1, .01 μF)
C44 (5494481-P110, 680 pF)	C44 (5494481-P124, 1500 pl
C45 (5494481-P104, 220 pF)	C45 (5490008-P27, 100 pF)
R45 (3R77-P123J, 12K)	R71 (3R77-P133J, 13K)
R48 (3R77-P332J, 3.3K)	R72 (3R77-P362J, 3.6K)
R53 (3R77-P303J, 30K)	R73 (3R77-P473J, 47K)
R54 (3R77-P822J, 8.2K)	R74 (3R77-P362J, 3.6K)
R68 (3R77-P752J, 7.5K)	R68 (3R77-P682J, 6.8K)
• • •	

#### REV. B - To make IF Audio & Squelch Board compatible with new PA transistors and to improve

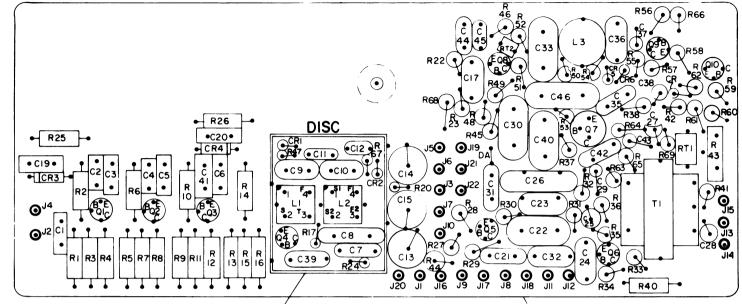
Deleted: C24, C28, C29, C42, C43, R32, R37, R63 and R65.

1: C49 (5496267-P9, 3.3 μF)
C50 (198209243-P7, 0.1 μF)
C51 (5494481-P127 0.0027 μF)
C52 (198209243-P17, 0.22 μF)
C53 (5496267-P213, 2.2 μF)
C54 (5496267-P213, 2.2 μF)
C78 (19817250-P1)
R75 (3877-P473J, 47,000 ohms ±5%)
R76 (3R152-P912J, 9,100 ohms ±5%)
R77 (3R152-P562J, 5,600 ohms ±5%)
R78 (3R77-P100J, 10 ohms ±5%)
R79 (3R152-P562J, 5,600 ohms ±5%)
R79 (3R152-P393J, 39,000 ohms ±5%)
R79 (3R152-P393J, 39,000 ohms ±5%)
R73 (5490828-P9, 10,000 ohms)

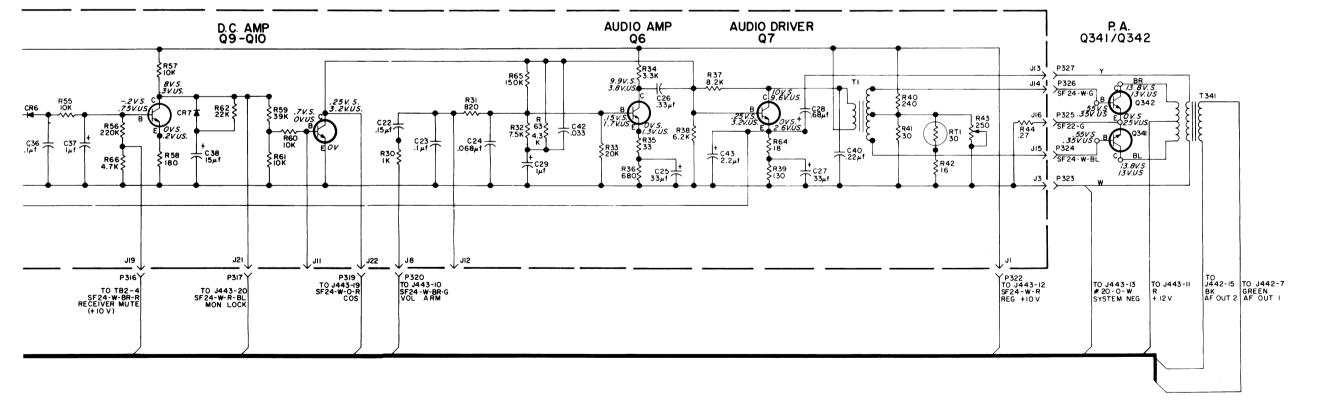
~ .	_	m.	
Changed	From	<u>To</u>	
C21	19B209243-P1, (01 μF)	19B209243-P3 (.022 μF	
C26	19B209243-P14 (.33 μF)	5496267-P28 (.47 μF)	
C37	5496267-P17 (1 μF)	5496267-P28 (.47 μF)	
C38	5496267-P14 (15 µF)	5496267-P10 (22 μF)	
C40	19B209243-P117 (.22 μF)	5496267-P28 (.47 μF)	
R33	C3R77P2O3J (20K)	C3R77P912J (9.1K)	
R38	C3R77P622J (6.2K)	C3R77P752J (7.5K)	
R39	C3R77P131J (130 )	C3R77P820J (82 )	
R41	C3R77P300J (30 )	C3R77P240J 24 )	
R42	C3R77P160J (16 )	C3R77P200J (20 )	
R48	C3R77P332J (3.3K)	C3R77P302J (3K)	
R53	C3R77P303J (30K)	C3R77P473J (47K)	
R62	C3R77P223J (22K)	C3R77P103J (10K)	

Outline Diagram Was:

### IF-AUDIO & SQUELCH BOARD A390



#### Schematic Diagram Was:



#### **PRODUCTION CHANGES**

LBI-3974

66—88 MHz MASTR RECEIVER MODELS 4ER40D10-15

Issue 1

**T** 

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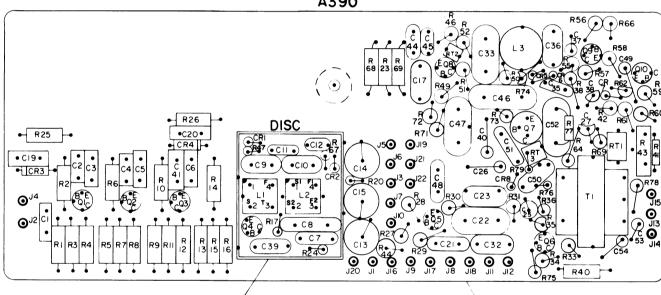
Deleted: C38, C49, CR7, CR8, R62, R75 and R76

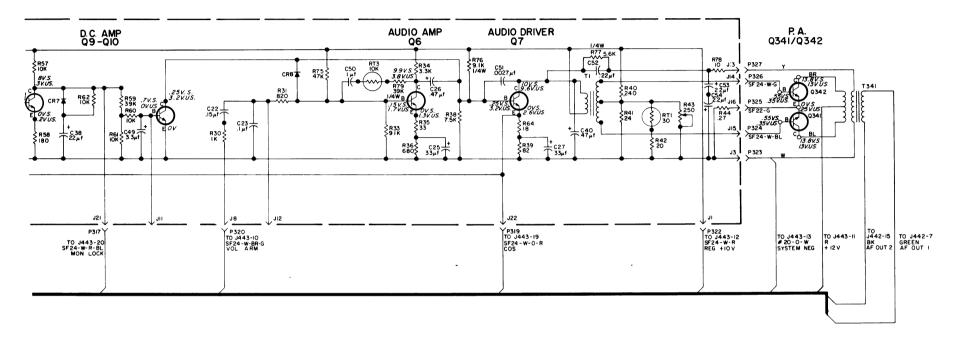
R80 (3R152P472J, 4.3K ohms ±5% R81 (3R152P472J, 4.7K ohms ±5%

Changed	From	<u>To</u>
C27	5496267-P6 (33 μF)	5496267-P2 (47 μF)
C36	19B209243-P7 (0.1 μF)	19B209243-P17 (0.22 μF)
R53	3R77-P473 (47K ohms)	3R77-P303J (30K ohms)
R64	3R77-P180J (19 ohms)	3R77-P120J (12 ohms)
R77	3R152-P562J (5.6 ohms)	3R152-P153J (15K ohms)

Outline Diagram Was:

## IF-AUDIO & SQUELCH BOARD A390





#### **ORDERING SERVICE PARTS**

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- GE Part Number for component
- 2. Description of part
- Model number of equipment Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

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